## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

STR-W6253MD

## 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators

## Features and Benefits

- Overcurrent protection (OCP) with AC input voltage compensation function; no additional peripheral circuits required-minimizes dependency of OCP on ac input
- Overload protection (OLP) with integrated timer reduces power stress (temperature rise) at overload condition, requires no peripheral components
- Avalanche-guaranteed MOSFET improves device capability of withstanding excess surge voltage, providing a simple surge absorber circuit without breakdown voltage derating
- Start-up circuit eliminates the need for a start-up resistor, and helps to reduce input power consumption

Continued on the next page...

## Package: TO-220

Not to scale


## Description

The STR-W6200D series are current-mode PWM ICs that incorporate controller chips. These devices are manufactured using a proprietary high-voltage BCD process, and avalancheguaranteed MOSFETs. These elements allow power supply systems designs that are highly reliable and simple, with fewer peripheral components. These ICs also provide Auto-Burst mode operation, which lowers input power requirements at light loads, and improves efficiency over the entire load range and universal-input range.

Applicatons include:

- TV set top box
- LCD PC monitor, LCD TV
- Printer, scanner
- General consumer, PC, and industrial applications requiring SMPS power supply with standby mode

Functional Block Diagram


# 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators 

## Features and Benefits (continued)

- Bias Assist function improves start-up performance by selfbiasing the VCC pin, and allows a use of a small value VCC capacitor, resulting in improved response to overvoltage conditions
- Very low current consumption in nonoperating (UVLO) state: $\mathrm{I}_{\mathrm{CC}(\text { off })}=5 \mu \mathrm{~A}$ (typical) at $\mathrm{V}_{\mathrm{CC}}=13.9 \mathrm{~V}$
- Slope compensation circuit stabilizes operation, preventing interference from subharmonics
- Leading Edge Blanking
- Various protections:
- Overcurrent Protection (OCP), pulse-by-pulse sensing
- Overload Protection (OLP), auto restart after certain duration
- External Latch Protection (ELP), latched
- Overvoltage Protection (OVP), latched
- Thermal Shut Down (TSD), latched
- Externally-activated shut down protection (ELP) for emergency system shut down
- Auto-Burst Standby function (pin $<0.1 \mathrm{~W}$ at zero output load condition)
- TO-220 full-molded package with 6 pins


## Selection Guide

| Part Number | Packing |
| :---: | :---: |
| STRW6253MD | 50 pieces per tube |

## Pin-out Diagram



Terminal List Table

| Number | Name | Description | Functions |
| :---: | :---: | :--- | :--- |
| 1 | D/ST | Drain/startup terminal | MOSFET drain and input of start-up signal |
| 2 | NC | Clipped | No connection |
| 3 | S/OCP | Source/Overcurrent Protection <br> terminal | MOSFET source and input of overcurrent <br> detection signal |
| 4 | VCC | Power supply terminal | Input of power supply for control circuit |
| 5 | GND | Ground terminal | Ground |
| 6 | FB | Feedback terminal | Input of constant voltage control signal |
| 7 | FM/ELP | Frequency jittering/External Latch <br> Protection terminal | Control input for frequency jittering control and <br> External Latch Protection |

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature, $\mathrm{T}_{\mathrm{A}}$, of $25^{\circ} \mathrm{C}$, unless otherwise stated.

ABSOLUTE MAXIMUM RATINGS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Terminal | Note | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain Current ${ }^{1}$ | $I_{\text {Dpeak }}$ | 1-3 | Single Pulse | 10 | A |
| Maximum Switching Current ${ }^{2}$ | $I_{\text {dmax }}$ | 1-3 | $\mathrm{T}_{\mathrm{A}}=-20^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 10 | A |
| Single Pulse Avalanche Energy ${ }^{3}$ | $\mathrm{E}_{\text {AS }}$ | 1-3 | Single Pulse | 86 | mJ |
|  | $I_{\text {Lpeak }}$ | 1-3 | $\mathrm{V}_{\mathrm{DD}}=99 \mathrm{~V}, \mathrm{~L}=20 \mathrm{mH}$ | 2.7 | A |
| S/OCP Terminal Voltage | $V_{\text {OCP }}$ | 3-5 |  | -6 to 6 | V |
| FM/ELP Terminal Voltage | $\mathrm{V}_{\text {FM }}$ | 7-5 |  | -0.3 to 12 | V |
| FM/ELP Terminal Inflow Current | $\mathrm{I}_{\text {FM }}$ | 7-5 |  | 3 | mA |
| FB Terminal Voltage | $\mathrm{V}_{\text {FB }}$ | 6-5 |  | -0.3 to 9 | V |
| Controller (MIC) Input Voltage | $\mathrm{V}_{\text {CC }}$ | 4-5 |  | 0 to 32 | V |
| MOSFET Power Dissipation ${ }^{4}$ | $\mathrm{P}_{\mathrm{D} 1}$ | 1-3 | With infinite heatsink | 27.5 | W |
|  |  |  | Without heatsink | 1.3 | W |
| Controller (MIC) Power Dissipation | $\mathrm{P}_{\mathrm{D} 2}$ | 4-5 |  | 0.8 | W |
| Operating Internal Frame Temperature | $\mathrm{T}_{\mathrm{F}}$ | - | Refer to $\mathrm{T}_{\text {OP }}$ | -20 to 115 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature | $\mathrm{T}_{\text {op }}$ | - |  | -20 to 115 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | - |  | -40 to 125 | ${ }^{\circ} \mathrm{C}$ |
| Channel Junction Temperature | TJ | - |  | 150 | ${ }^{\circ} \mathrm{C}$ |

## ${ }^{1}$ Refer to figure 1

$\left.{ }^{2}\right|_{\text {DMAX }}$ is the drain current on the D/ST pin determined by the drive voltage of the IC and the threshold voltage, $\mathrm{V}_{\text {th }}$, of the MOSFET
${ }^{3}$ Refer to figure 3
${ }^{4}$ Refer to figure 5

Figure 1 - MOSFET Safe Operating Area Derating Curve


Figure 2 - MOSFET Safe Operating Area Drain Current versus Voltage at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Single Pulse


Figure 3 - MOSFET Avalanche Energy Derating Curve


Figure 4 - Transient Thermal Resistance


Figure 5 - MOSFET Power Dissipation versus Temperature


# 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators 

ELECTRICAL CHARACTERISTICS valid at $\mathrm{V}_{\mathrm{CC}}=18 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Characteristic | Symbol | Terminal | Test Conditions | Min. | Typ. | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Start-up Operation |  |  |  |  |  |  |  |
| Operation Start Voltage | $\mathrm{V}_{\mathrm{CC}(\mathrm{ON})}$ | 4-5 | (VCC voltage at which operation starts) Measurement circuit $1, \mathrm{~V}_{\mathrm{CC}}=0$ through 13.9 to 17.1 V | 13.9 | 15.5 | 17.1 | V |
| Operation Stop Voltage | $\mathrm{V}_{\text {CC(OFF) }}$ | 4-5 | (VCC voltage at which operation stops) Measurement circuit $1, \mathrm{~V}_{\mathrm{CC}}=17.1$ through 9.8 to 8.0 V | 8.0 | 8.9 | 9.8 | V |
| Circuit Current in Operation | ICC(ON) | 4-5 | (Inflow current into VCC terminal in oscillation) Measurement circuit 1 | - | 1.4 | 2.8 | mA |
| Circuit Current in Non-Oscillation | $\mathrm{I}_{\text {CC(STOP }}$ | 4-5 | (Inflow current into VCC terminal at $\mathrm{V}_{\mathrm{FB}}=0 \mathrm{~V}$ ) Measurement circuit 1 | - | 0.8 | 1.3 | mA |
| Circuit Current in Non-Operation | ICC(OFF) | 4-5 | (Inflow current into VCC terminal prior to oscillation) Measurement circuit 1, $\mathrm{V}_{\mathrm{CC}}=13.8$ | - | 5 | 20 | $\mu \mathrm{A}$ |
| Start-up Current | $I_{\text {startup }}$ | 4-5 | (Inflow current into D/ST terminal) Measurement circuit $7, \mathrm{~V}_{\mathrm{CC}}=0, \mathrm{D} / \mathrm{ST}=450 \mathrm{~V}$ | -0.9 | -1.6 | -2.3 | mA |
| Bias Assist Voltage | $V_{\text {BIAS }}$ | 4-5 | (VCC voltage at which $I_{\text {startup }}$ starts, and $\mathrm{I}_{\text {startupBias }}$ begins) Measurement circuit 7, $\mathrm{V}_{\mathrm{CC}}=17.1$ through 13.6 to 16.8 V | 13.6 | 15.2 | 16.8 | V |
| Operating Characteristics |  |  |  |  |  |  |  |
| FM/ELP High Threshold Voltage | $\mathrm{V}_{\mathrm{FM}(\mathrm{H})}$ | 7-5 | (FM/ELP terminal voltage at which $\mathrm{I}_{\text {FM }}$ changes from $-13 \mu \mathrm{~A}$ to $13 \mu \mathrm{~A}$ ) Measurement circuit 2 | 4.0 | 4.5 | 5.0 | V |
| FM/ELP Low Threshold Voltage | $\mathrm{V}_{\mathrm{FM}(\mathrm{L})}$ | 7-5 | (FM/ELP terminal voltage at which $\mathrm{I}_{\text {FM }}$ changes from $13 \mu \mathrm{~A}$ to $-13 \mu \mathrm{~A}$ ) Measurement circuit 2 | 2.4 | 2.8 | 3.2 | V |
| FM/ELP Voltage Difference | $\Delta \mathrm{V}_{\mathrm{FM}}$ | 7-5 | $\left(\mathrm{V}_{\text {FM }(H)}-\mathrm{V}_{\mathrm{FM}(\mathrm{L})}\right)$ Measurement circuit 2 | 1.4 | 1.7 | 1.8 | V |
| FM/ELP Outflow Current ${ }^{1}$ | $\mathrm{I}_{\text {FMsic }}$ | 7-5 | (FM/ELP terminal outflow current at $\mathrm{V}_{\mathrm{FM}}=\mathrm{V}_{\mathrm{FM}(\mathrm{L})}$ ) Measurement circuit 2 | -17.4 | -13 | -8.6 | $\mu \mathrm{A}$ |
| FM/ELP Inflow Current ${ }^{1}$ | $\mathrm{I}_{\text {FMsink }}$ | 7-5 | (FM/ELP terminal inflow current at $\mathrm{V}_{\mathrm{FM}}=\mathrm{V}_{\mathrm{FM}(\mathrm{H})}$ ) Measurement circuit 2 | 8.6 | 13 | 17.4 | $\mu \mathrm{A}$ |
| Average Switching Frequency | fosc(av) | 1-5 | (D/ST terminal average oscillation frequency) Measurement circuit 2 | 60 | 67 | 74 | kHz |
| Frequency Jitter Deviation | $\Delta f$ | 1-5 | fosc (peak-to-peak) Measurement circuit 2 | 4.8 | 6.9 | 9 | kHz |
| Maximum Duty Cycle (On-Duty) | $\mathrm{D}_{\text {max }}$ | 1-5 | (Maximum width of the low portion of the D/ST terminal waveform) Measurement circuit 2 | 71 | 75 | 79 | \% |
| Maximum Feedback Current ${ }^{1}$ | $I_{\text {FB(MAX }}$ | 6-5 | (FB terminal outflow current at $\mathrm{V}_{\mathrm{FB}}=0 \mathrm{~V}$ ) Measurement circuit 3 | -220 | -160 | -100 | $\mu \mathrm{A}$ |
| Standby Operation Start-up Threshold Voltage | $\mathrm{V}_{\text {Stig }}$ | 6-5 | Set $\mathrm{V}_{\mathrm{FM}}=0 \mathrm{~V}$ and decrease $\mathrm{V}_{\mathrm{FB}}\left(\mathrm{V}_{\mathrm{STBY}}\right.$ is the FB terminal voltage level at which D/ST changes from low to high) Measurement circuit 3 | 0.99 | 1.10 | 1.21 | V |
| Slope Compensation Start-up Duty Cycle | $\mathrm{D}_{\text {SLP }}$ | 6-5 | $D_{\text {SLP }}=(t 3 / t 4) \times 100$ (see figure for measurement circuit 4 for values of $t$ ) Measurement circuit 4 | - | 27 | - | \% |
| Slope Compensation Rate | SLP | 6-5 | $S L P=0.02 /(t 2-t 1)$ (see figure for measurement circuit 4 for values of $t$ ) Measurement circuit 4 | -22 | -17 | -12 | $\mathrm{mV} / \mu \mathrm{s}$ |

Continued on next page...

## 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators

ELECTRICAL CHARACTERISTICS, continued, valid at $\mathrm{V}_{\mathrm{CC}}=18 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Characteristic | Symbol | Terminal | Test Conditions | Min. | Typ. | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Protection Operation |  |  |  |  |  |  |  |
| OCP Threshold Voltage at Zero Duty Cycle (0\% On-Duty) | Vocp1 | 3-5 | Set $\mathrm{V}_{\mathrm{FM}}=0 \mathrm{~V}$ and increase $\mathrm{V}_{\text {OCP. }}\left(\mathrm{V}_{\mathrm{OCP} 1}\right.$ is the $\mathrm{S} / \mathrm{OCP}$ terminal voltage level at which D/ST changes from low to high) Measurement circuit 5 | 0.71 | 0.78 | 0.86 | V |
| Drain Peak Current Compensation Coefficient | DPC | - | $\mathrm{D}_{\text {PC }}=-0.75 \times$ SLP / fosc(av) | 1.5 | 1.9 | 2.3 | $\begin{gathered} \mathrm{mVI} \\ \mathrm{DC} \% \end{gathered}$ |
| OCP Threshold Voltage After Compensation | Vocp2 | 3-5 | $\mathrm{V}_{\text {OCP2 }}=\mathrm{D}_{\text {PC }} \times \mathrm{D}_{\text {MAX }}+\mathrm{V}_{\text {OCP1 }}$ | 0.82 | 0.93 | 1.04 | V |
| Leading Edge Blanking Time | $\mathrm{t}_{\text {blank }}$ | 1-5 | (The low portion of the D/ST terminal waveform at $\mathrm{V}_{\mathrm{OCP}}=2 \mathrm{~V}$ ) Measurement circuit 5 | 280 | 400 | 520 | ns |
| OLP Delay Time ${ }^{2}$ | tolp | 1-5 | (Time between setting FB terminal open and when oscillation stops) Measurement circuit 6 | - | 400 | - | ms |
| Circuit Current in OLP-Operation | ICC (OLP) | 4-5 | (Inflow current into VCC terminal after OLP operation) Measurement circuit 6 | - | 1.2 | 1.9 | mA |
| OVP Protection Voltage | $\mathrm{V}_{\mathrm{cc} \text { ( } \mathrm{OVP} \text { ) }}$ | 4-5 | Set $\mathrm{V}_{\mathrm{FM}}=0 \mathrm{~V}$ and increase $\mathrm{V}_{\mathrm{CC}}$ (VCC terminal voltage at which the voltage of D/ST terminal is switched from low to high) Measurement circuit 1, $\mathrm{V}_{\mathrm{CC}}=18.0 \mathrm{~V}$ through 27 to 30 V | 27 | 28.5 | 30 | V |
| Latch Circuit Sustaining Current ${ }^{3}$ | $\mathrm{I}_{\mathrm{CC}(\text { La. } \mathrm{H})}$ | 4-5 | (Inflow current into VCC terminal after OVP operation) Measurement circuit $1, \mathrm{~V}_{\mathrm{CC}}=8 \mathrm{~V}$ | - | 140 | 220 | $\mu \mathrm{A}$ |
| Latch Circuit Release Voltage ${ }^{3}$ | $\mathrm{V}_{\text {CC(La.OFF) }}$ | 4-5 | (VCC voltage at which $\mathrm{I}_{\mathrm{cc}}$ is dropped below $20 \mu \mathrm{~A}$ by decreasing $\mathrm{V}_{\mathrm{CC}}$ after OVP operation) $\mathrm{V}_{\mathrm{CC}}=31.0 \mathrm{~V}$ through 7.8 to 6.4 V | 6.4 | 7.1 | 7.8 | V |
| ELP Threshold Voltage | $\mathrm{V}_{\text {ELP }}$ | 7-5 | (FM/ELP terminal voltage at which the oscillation of the D/ST terminal waveform is stopped by increasing $V_{F M}$ ) Measurement circuit 2 | 6.4 | 7.1 | 7.8 | V |
| Inflow Current at External Latch Protection | $I_{\text {ELP }}$ | 7-5 |  | - | 55 | 100 | $\mu \mathrm{A}$ |
| Thermal Shutdown Operating Temperature | $\mathrm{T}_{\text {JTSD }}$ | - |  | 135 | - | - | ${ }^{\circ} \mathrm{C}$ |
| Power MOSFET Characteristics |  |  |  |  |  |  |  |
| Drain-to-Source Breakdown Voltage | $V_{\text {DSS }}$ | 1-3 | $\mathrm{I}_{\mathrm{D}}=300 \mu \mathrm{~A}$, Measurement circuit 8 | 650 | - | - | V |
| Drain Leakage Current | $\mathrm{I}_{\text {DSs }}$ | 1-3 | $V_{D S}=650 \mathrm{~V}, \mathrm{~V}_{C C}=13 \mathrm{~V}$, Measurement circuit 7 | - | - | 300 | $\mu \mathrm{A}$ |
| ON-Resistance | $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ | 1-3 | $\mathrm{I}_{\mathrm{D}}=1.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{FM}}=0 \mathrm{~V}$ Measurement circuit 10 | - | - | 1.9 | $\Omega$ |
| Switching Time | $\mathrm{t}_{\mathrm{r}}$ | 1-3 | Measurement circuit 9 | - | - | 400 | ns |
| Thermal Resistance | $\mathrm{R}_{\text {өJ-F }}$ | - | Measured between junction and internal frame | - | - | 1.75 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Single Pulse Avalanche Energy | $\mathrm{E}_{\text {AS }}$ | - | Measurement circuit 11 | - | - | - | - |

${ }^{1}$ Input and output current polarity at the device pin; plus(+) represents sink and minus(-) represents source.
${ }^{2}$ The reference value when applying 47 nF between the FM/ELP terminal and GND.
${ }^{3}$ The latch circuit means a circuit operated ELP, OVP, TSD, and OLP.

Measurement Circuit 1


Measurement Circuit 2


Measurement Circuit 3
 www.allegromicro.com

Measurement Circuit 4


Measurement Circuit 5


## Measurement Circuit 6




Measurement Circuit 8

## Measurement Circuit 7



Measurement Circuit 9


## Measurement Circuit 10



## Measurement Circuit 11



## TYPICAL APPLICATION CIRCUIT

 www.allegromicro.com

## 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators

## PACKAGE DIMENSIONS, TO-220




1234567


Deflection at pin bend View A


Deflection at pin tip View B

Terminal core material: Cu
Terminal treatment: Ni plating and solder dip
Leadform: 2003
Weight (approximate): 2.3 g
Dimensions in millimeters

Drawing for reference only
Branding codes (exact appearance at manufacturer discretion): 1st line, type: W6253DM 2nd line, lot: YMDD R

Where: Y is the last digit of the year of manufacture M is the month (1 to $9, O, N, D$ )
DD is the 2-digit date
$R$ is the manufacturer registration symbol

Leadframe plating Pb -free. Device composition complies with the RoHS directive.

Shipping Tube Dimensions:
Wall thickness: $0.6 \pm 0.3 \mathrm{~mm}$
Wall warp: <2 mm
Material: Hardened polyvinyl
Coating: antistatic
Tolerance $\pm 0.4 \mathrm{~mm}$, unless otherwise specified

Shipping Carton Dimensions:
Capacity: 1800 pieces maximum per carton 36 tubes per carton 3 rows, 12 tubes per row

All dimensions: mm


# 60 W-Universal Input/90 W-230 Vac Input PWM Switching Regulators 



WARNING - These devices are designed to be operated at lethal voltages and energy levels. Circuit designs that embody these components must conform with applicable safety requirements. Precautions must be taken to prevent accidental contact with power-line potentials. Do not connect grounded test equipment.

The use of an isolation transformer is recommended during circuit development and breadboarding.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

## Cautions for Storage

- Ensure that storage conditions comply with the standard temperature ( $5^{\circ} \mathrm{C}$ to $35^{\circ} \mathrm{C}$ ) and the standard relative humidity (around 40 to $75 \%$ ); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust in leads and solderability of products that have been stored for a long time.

Cautions for Testing and Handling
When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between adjacent products, and shorts to the heatsink.

## Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce stress.
- Volatile-type silicone greases may produce cracks after long periods of time, resulting in reduced heat radiation effect. Silicone grease with low consistency (hard grease) may cause cracks in the mold resin when screwing the product to a heatsink.
- Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

| Type | Suppliers |
| :---: | :---: |
| G746 | Shin-Etsu Chemical Co., Ltd. |
| YG6260 | GE Toshiba Silicone Co., Ltd. |
| SC102 | Dow Corning Toray Co., Ltd. |

## Soldering

- When soldering the products, please be sure to minimize the working time, within the following limits:
$260 \pm 5^{\circ} \mathrm{C} \quad 10 \mathrm{~s}$
$350 \pm 5^{\circ} \mathrm{C} \quad 3 \mathrm{~s}$
- Soldering iron should be at a distance of at least 1.5 mm from the body of the products


## Electrostatic Discharge

- When handling the products, operator must be grounded. Grounded wrist straps worn should have at least $1 \mathrm{M} \Omega$ of resistance to ground to prevent shock hazard.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons or the solder bath must be grounded in other to prevent leak voltages generated by them from being applied to the products.
- The products should always be stored and transported in our shipping containers or conductive containers, or be wrapped in aluminum foil.


## Assembly

- During soldering or other operations, the interior frame temperature of the device should never exceed $105^{\circ} \mathrm{C}$.
- Recommended screw torque through the mounting tab is 0.588 to $0.785 \mathrm{~N} \cdot \mathrm{~m}(6$ to $8 \mathrm{kgf} \cdot \mathrm{cm})$

The products described herein are manufactured in Japan by Sanken Electric Co., Ltd. for sale by Allegro MicroSystems, Inc.
Sanken and Allegro reserve the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Therefore, the user is cautioned to verify that the information in this publication is current before placing any order.

When using the products described herein, the applicability and suitability of such products for the intended purpose shall be reviewed at the users responsibility.

Although Sanken undertakes to enhance the quality and reliability of its products, the occurrence of failure and defect of semiconductor products at a certain rate is inevitable.

Users of Sanken products are requested to take, at their own risk, preventative measures including safety design of the equipment or systems against any possible injury, death, fires or damages to society due to device failure or malfunction.

Sanken products listed in this publication are designed and intended for use as components in general-purpose electronic equipment or apparatus (home appliances, office equipment, telecommunication equipment, measuring equipment, etc.). Their use in any application requiring radiation hardness assurance (e.g., aerospace equipment) is not supported.

When considering the use of Sanken products in applications where higher reliability is required (transportation equipment and its control systems or equipment, fire- or burglar-alarm systems, various safety devices, etc.), contact a company sales representative to discuss and obtain written confirmation of your specifications.

The use of Sanken products without the written consent of Sanken in applications where extremely high reliability is required (aerospace equipment, nuclear power-control stations, life-support systems, etc.) is strictly prohibited.

The information included herein is believed to be accurate and reliable. Application and operation examples described in this publication are given for reference only and Sanken and Allegro assume no responsibility for any infringement of industrial property rights, intellectual property rights, or any other rights of Sanken or Allegro or any third party that may result from its use.

Copyright © 2007 Allegro MicroSystems, Inc.
This datasheet is based on Sanken datasheet SSE24071

